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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.

10/509,370

Confirmation No.: 3987

First Named Inventor

Takuya SUGAWARA
September 28, 2004

Filed

: 1765

TC/A.U.

. 1700

Examiner

D. V. N. Deo

Docket No.

101249.55459US

Customer No.

23911

Title

Method for Forming Insulation Film

SUPPLEMENTAL REPLY

Mail Stop AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

The following supplemental remarks are submitted in furtherance to the Request for Reconsideration filed on October 31, 2007.

The present invention relates to a process for forming an insulating film on the surface of a substrate. As recited in independent claim 16, the process comprises cleaning the substrate with plasma using a cleaning gas, oxidizing the substrate with plasma using an oxidizing gas to form an oxide film thereon, nitriding the oxide film with plasma using a nitriding gas and after the nitriding, treating the oxide film with plasma based on a treating gas comprising hydrogen gas.

The process according to independent claim 25 comprises cleaning the substrate with plasma using a cleaning gas, nitriding the substrate with plasma based on a nitriding gas to form a nitride film thereon, oxidizing the nitride film